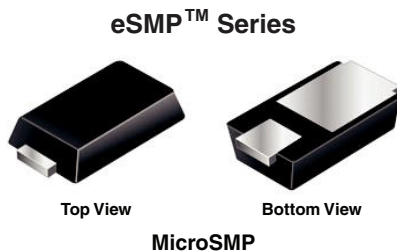


Surface Mount TRANSZORB[®] Transient Voltage Suppressors



PRIMARY CHARACTERISTICS	
V_{WM}	5.0 V
P_{PPM}	100 W
I_{FSM}	25 A
T_J max.	150 °C

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting on ICs, MOSFET, signal lines of sensor units specifically for protecting 5.0 V supplied sensitive equipment against transient overvoltages.

FEATURES

- Very low profile - typical height of 0.65 mm
- Ideal for automated placement
- Oxide planar chip junction
- Uni-directional polarity only
- Peak pulse power: 100 W (10/1000 μ s)
- ESD capability: **15 kV (air), 8 kV (contact)**
- Meets MSL level 1, per J-STD-020C, LF maximum peak of 260 °C
- Solder dip 265 °C max. 10 s, per JESD 22-A111
- AEC-Q101 qualified
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- **Halogen-free according to IEC 61249-2-21 definition**
- Find out more about Vishay's Automotive Grade Product requirements at: www.vishay.com/applications



RoHS
COMPLIANT
HALOGEN
FREE

AUTOMOTIVE
GRADE
Available

MECHANICAL DATA

Case: MicroSMP

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free and RoHS compliant, commercial grade

Base P/NHM3 - halogen-free and RoHS compliant, automotive grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	VALUE	UNIT
Peak pulse power dissipation ⁽¹⁾⁽²⁾	P_{PPM}	100	W
Peak pulse current with a 10/1000 μ s waveform (fig. 1)	I_{PPM}	10.9	A
Non repetitive peak forward surge current 10 ms single half sine-wave ⁽²⁾	I_{FSM}	25	A
Power dissipation $T_L = 120$ °C ⁽²⁾	P_D	1.0	W
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 150	°C

Notes

⁽¹⁾ Non-repetitive current pulse, per fig. 1

⁽²⁾ Mounted on 6.0 mm x 6.0 mm copper pads to each terminal

**ELECTRICAL CHARACTERISTICS** ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

DEVICE TYPE	DEVICE MARKING CODE	BREAKDOWN VOLTAGE V_{BR} AT I_T ⁽¹⁾ (V)		TEST CURRENT I_T (mA)	STAND-OFF VOLTAGE V_{WM} (V)	MAXIMUM REVERSE LEAKAGE AT V_{WM} I_D (μA)	MAXIMUM CLAMPING VOLTAGE ⁽²⁾ V_C (V) AT I_{PPM} (A) 10/1000 μs		MAXIMUM CLAMPING VOLTAGE ⁽²⁾ V_C (V) AT I_{PPM} (A) 8/20 μs	
		MIN.	MAX.							
MSP5.0A	AE	6.40	7.07	10	5.0	100	9.2	10.9	14.5	57

Notes(1) Pulse test: $t_p \leq 50\text{ ms}$

(2) Surge current waveform per Fig. 1 and derate per Fig. 2

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	VALUE	UNIT
Typical thermal resistance ⁽¹⁾	$R_{\theta JA}$ $R_{\theta JL}$	125 30	$^\circ\text{C/W}$

Note(1) Thermal resistance from junction to ambient and junction to lead mounted on P.C.B. with 6.0 mm x 6.0 mm copper pad areas. $R_{\theta JL}$ is measured at the terminal of cathode band.**IMMUNITY TO STATIC ELECTRICAL DISCHARGE TO THE FOLLOWING STANDARDS** ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}$, $R = 1.5\text{ k}\Omega$	V_C	H3B	> 8 kV
IEC-61000-4-2 ⁽²⁾	Human body model (air discharge mode) ⁽¹⁾	$C = 150\text{ pF}$, $R = 150\text{ }\Omega$		4	> 15 kV

Notes

(1) Immunity to IEC-61000-4-2 air discharge mode has a typical performance > 30 kV

(2) System ESD standard

ORDERING INFORMATION (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
MSP5.0A-E3/89A	0.006	89A	4500	7" diameter plastic tape and reel
MSP5.0AHE3/89A ⁽¹⁾	0.006	89A	4500	7" diameter plastic tape and reel
MSP5.0A-M3/89A	0.006	89A	4500	7" diameter plastic tape and reel
MSP5.0AHM3/89A ⁽¹⁾	0.006	89A	4500	7" diameter plastic tape and reel

Note

(1) Automotive grade



RATINGS AND CHARACTERISTICS CURVES

($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

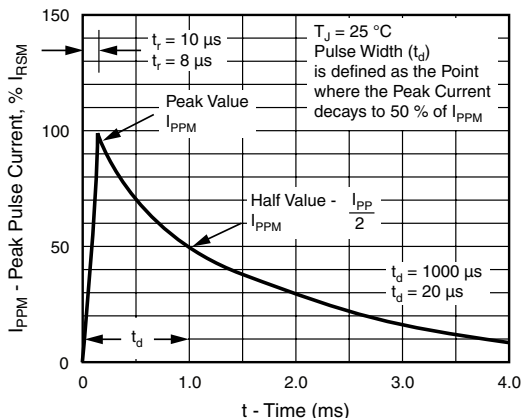


Figure 1. Pulse Waveform

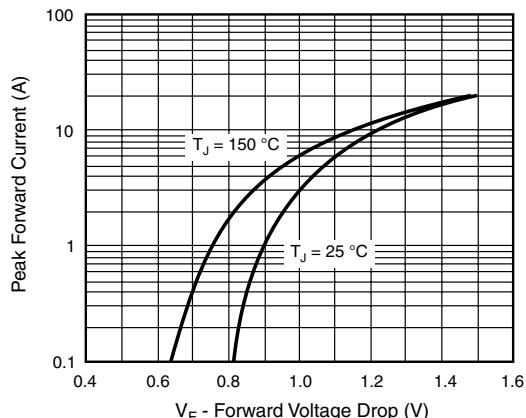


Figure 4. Typical Peak Forward Voltage Drop vs. Peak Forward Current

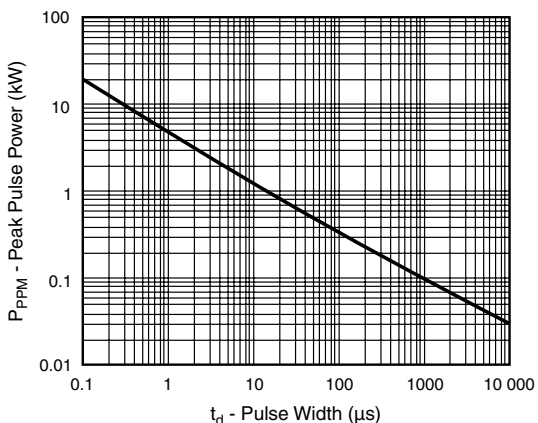


Figure 2. Peak Pulse Power Rating Curve

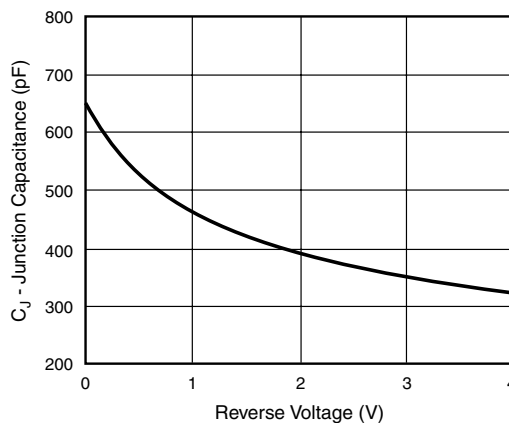


Figure 5. Typical Junction Capacitance

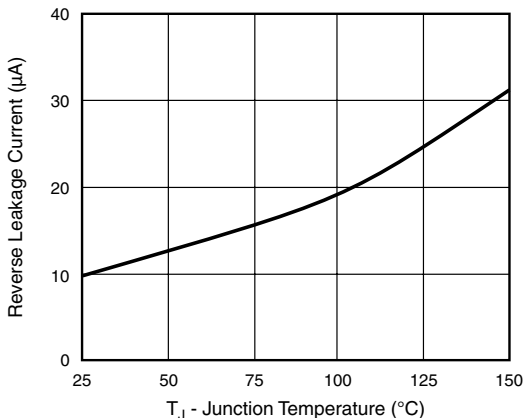


Figure 3. Relative Variation of Leakage Current vs. Junction Temperature

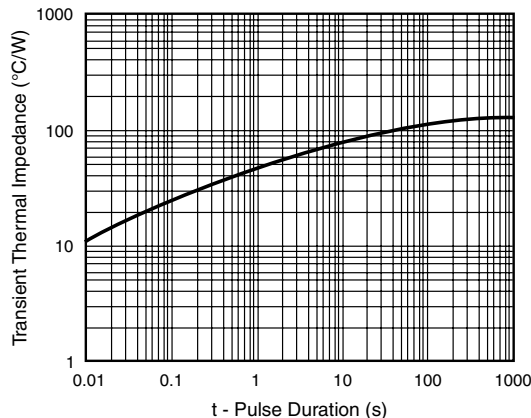
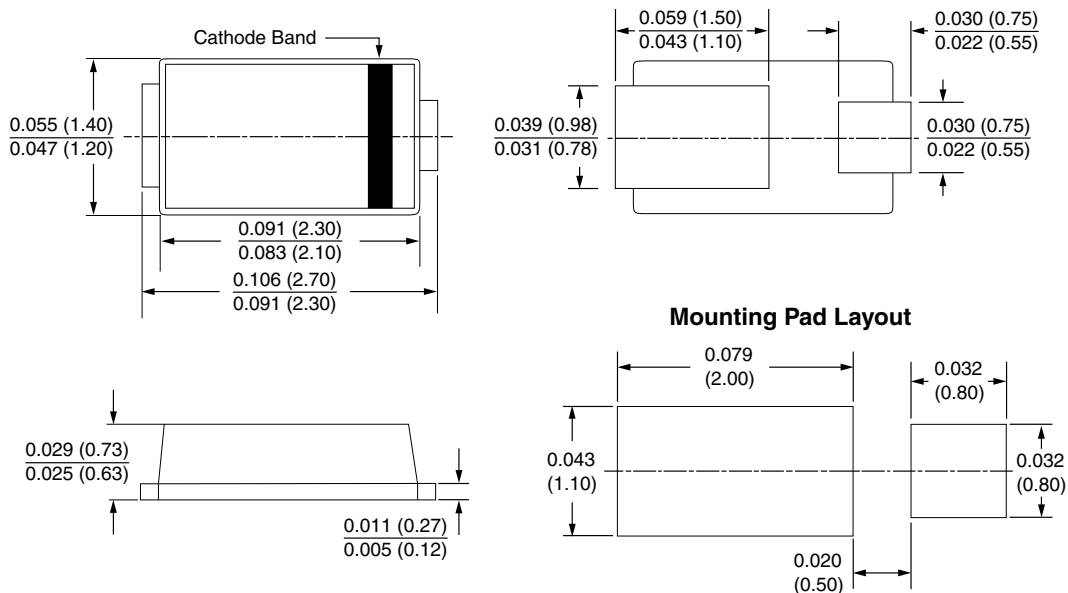


Figure 6. Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

MicroSMP





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